

Uni-polar, Nano Power Hall-Effect Switch IC



1 Product Description

The MT869X family is produced with CMOS technology. The Hall IC internally includes high sensitivity horizontal hall plates, sleep/awake logics for mode control, a low-power on-chip oscillator, low noise analog signal chain with dynamic offset cancellation, hysteresis comparators and an output driver.

The product responds to North pole or South pole magnetic fields. The output will be turned on (Low) when the magnetic flux density (B) is larger than the operating point (BOP), and be turned off (High) when the magnetic flux density (B) is lower than the releasing point (BRP).

The MT869X family provides a variety of packages to customers: DFN & SOT-23 for surface mount and flat TO-92 for through-hole mount. All packages are RoHS compliant.

2 Features

- CMOS Technology
- Uni-polar Switch
- 2.0 ~ 5.5V Operating Vcc Range
- -40°C~125°C Operating Temperature
- Package Option:

SOT-23

Flat TO-92

DFN1608

DFN1616

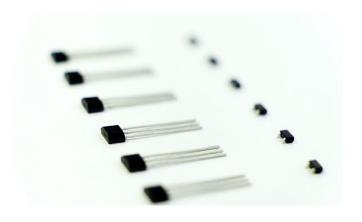
Magnetic Sensitivity Option:

BOP=35Gs, BRP=25Gs

- Push Pull Output
- Nano Power Consumption:
 Average Supply Current =600nA (Vcc=2.0V)
- RoHS Compliant: (EU)2015/863

3 Product Overview of MT869X

Part No.	Description
MT8691A	Flat TO-92, bulk packaging (1000pcs/bag)
MT8691AT	SOT-23, tape & reel (3000pcs/bag)
MT8691DT-1608	DFN1608, tape & reel (10000pcs/bag)
MT8691DT-1616	DFN1616, tape & reel (3000pcs/bag)



4 Applications

- Home appliances, Industrial
- Position Detection
- Solid-State Switch
- Proximity Switch
- Smart Meter
- Handheld Device
- Consumer Device

5. Pin Configuration and Functions

	Vcc	Out	GND
SOT-23	1	2	3
Flat TO-92	1	3	2
DFN1608	1	2	3
DFN1616	4	5	2
Description	Power	Output Push Pull	Ground

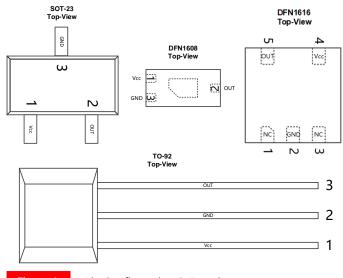




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Reversion History

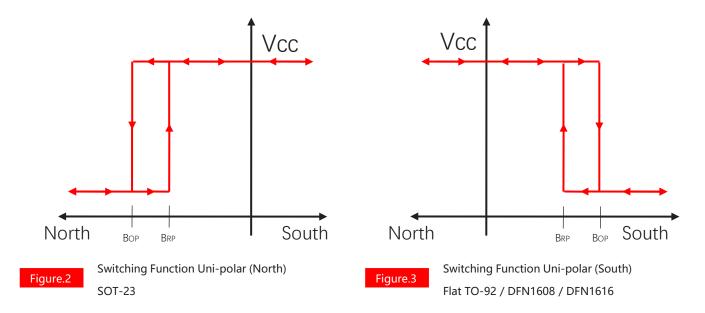
- 1 Originally Version
- 2 1.1 Version
- 3 1.2 Version
- 4 1.3 Version

Update the law max spec from 4mA to 5mA Update the marking spec of SOT-23 Update DFN1616



6 Definition of Switching Function

Figure.2 & Figure.3 shows the device functionality and hysteresis



7 Function Description

Bop: Operating Point, Magnetic flux density applied on the branded side of the package which turns the output driver ON (Vout=Low)

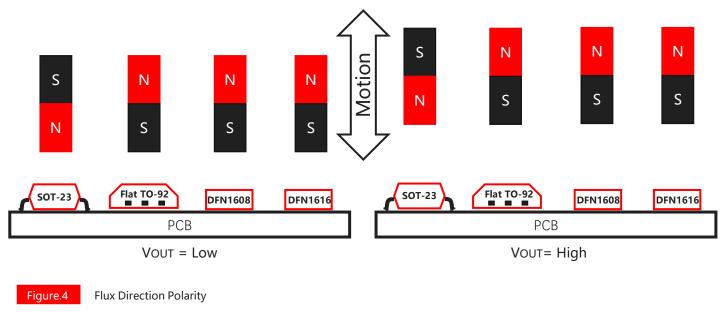
BRP: Releasing Point, Magnetic flux density applied on the branded side of the package which turns the output driver OFF (Vout=High)

BHYST: Hysteresis Window, |BOP - BRP|

Devices that have a lower magnetic threshold (Vout=High) detect magnets at a farther distance. Higher thresholds (Vout=Low) generally require a closer distance or larger magnet.

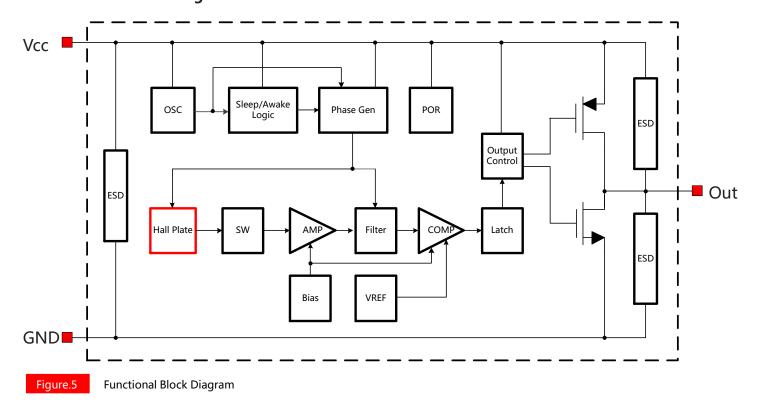
8 Feature Description

The MT869X device is sensitive to the magnetic field component that is perpendicular to the top of the package





9 Functional Block Diagram



10 Electrical and Magnetic Characteristics

10.1 Absolute Maximum Ratings

Absolute maximum ratings are limited values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.

Symbol	Parameters	Min	Max	Units
Vcc	Supply Voltage	-	7	V
VRCC	Reverse Battery Voltage	-0.5	-	V
Vout	Output Voltage	-	7	V
Гоит	Continuous Output Current	-	8	mA
TA	Operating Ambient Temperature	-40	125	°C
Ts	Storage Temperature	-50	150	°C
TJ	Junction Temperature	-	165	°C
В	Magnetic Flux Density	No	Limit	Gs



10.2 Electrical Specifications

At Ta=-40~125°C, Vcc=2.0V~5.5V (unless otherwise specified)

Symbol	Parameters	Test Condition	Min	Тур	Max	Unit
Vcc	Supply Voltage	Operating	2.0	3.6	5.5	V
lcc	Supply Current	Vcc=3.6V	-	1.2	2.0	uA
ICC	Supply Current	Vcc=2.0V	-	600	-	nA
law	Awake Current	Vcc=3.6V	-	3.0	5.0	mA
Isl	Sleep Current	Vcc=3.6V	-	0.6	1.4	uA
Vol	Output Low Voltage	IOUT=5mA, $ B > BOP $	-	-	0.4	V
Vон	Output High Voltage	IOUT=5mA, B < BRP	Vcc- 0.4	-	-	V
Fsw	Switching Frequency	Vcc=3.6V	10	20	40	Hz
Taw	Awake Time	Vcc=2.0V to 5.5V	4	10	16	us
Tsl	Sleep Time	Vcc=2.0V to 5.5V	25	50	100	ms
D.C.	Duty Cycle	Vcc=2.0V to 5.5V	-	0.02	-	%
Тро	Power on Time	dVcc/dt>5V/us, B > BOP	-	-	120	us
	Thermal Resistance of S	SOT-23	-	301	-	°C/W
Rтн	Thermal Resistance of I	DFN	-	301	-	°C/W
	Thermal Resistance of F	Flat TO-92	-	230	-	°C/W

10.3 Magnetic Characteristics

At Vcc=2.0V~5.5V (unless otherwise specified)

Part No.	Symbol	Min	Тур	Max	Unit
MT8691 Series	BOP, TA =25°C	15	35	55	Gs
	BRP, TA =25°C	10	25	40	Gs
	BHYST, TA =25℃	-	10	-	Gs

10.4 ESD Ratings

Symbo	I	Reference	Values	Unit
Vesd	Human-body model (HBM)	AEC-Q100-002	±5000	V
	Charged-device model (CDM)	AEC-Q100-011	±1000	V



10.5 Characteristic Performance

At Vcc=3.6V

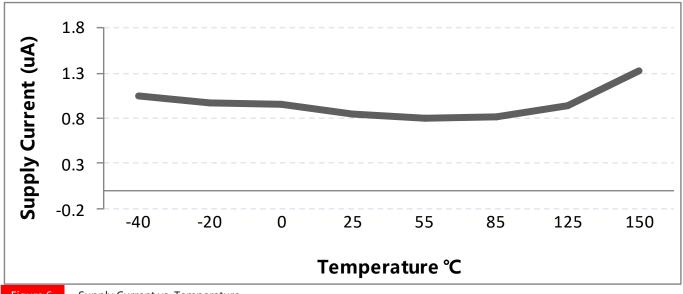


Figure.6 Supply Current vs. Temperature

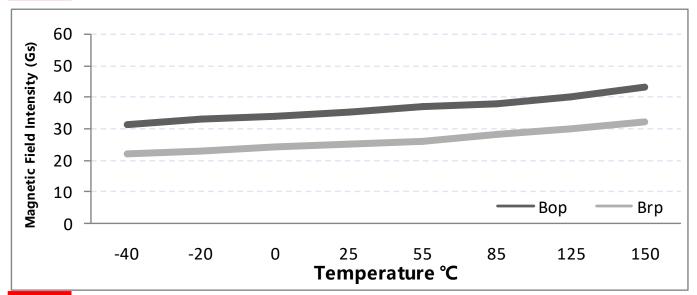


Figure.7 Magnetic Characteristics vs. Temperature (Bop & Brp)

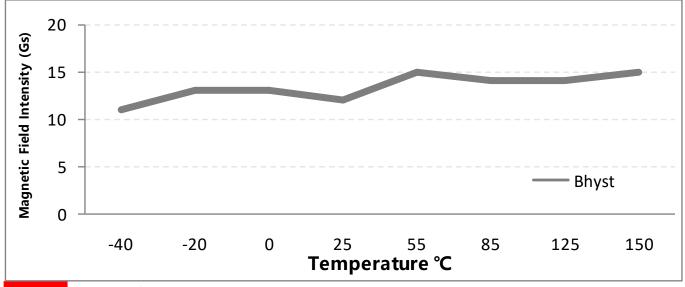


Figure.8 Magnetic Characteristics vs. Temperature (BHYST)



10.6 Typical Output Waveform

MT8691A as example

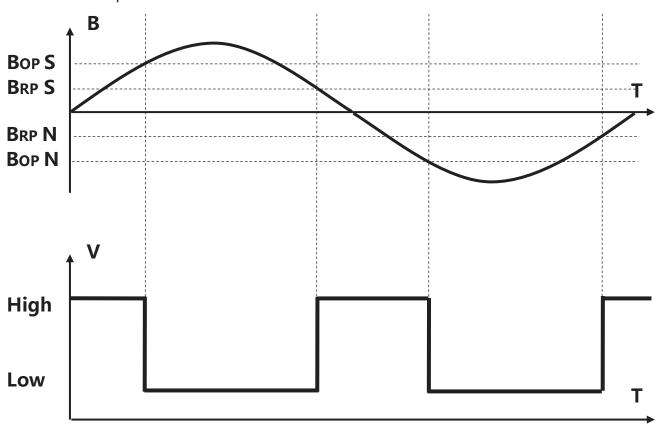


Figure.9

Digital Output vs. Magnetic Flux Density

11 Typical Application Circuit

MT8691AT as example

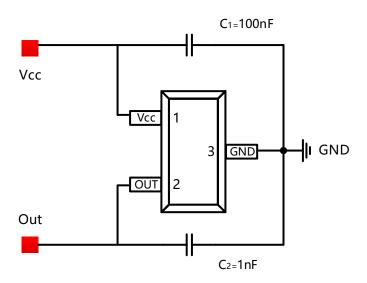


Figure.10 Typical Application Circuit



12 Package Material Information (For Reference Only – Not for Tooling Use)

12.1 SOT-23 Package Information

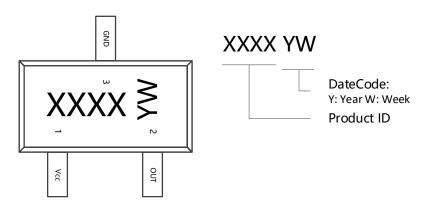


Figure.11 SOT-23 Chip Marking Spec

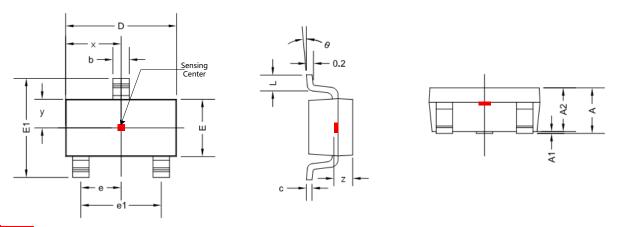


Figure.12 SOT-23 Package Drawing

Symbol	Dimensions i	Dimensions in Millimeters		s in Inches
	Min	Max	Min	Max
А	-	1.300	-	0.0512
A1	0.000	0.150	0.0000	0.0059
A2	1.000	1.200	0.0394	0.0472
b	0.300	0.500	0.0118	0.0197
С	0.080	0.220	0.0031	0.0087
D	2.800	3.000	0.1102	0.1181
E	1.500	1.700	0.0591	0.0669
E1	2.600	3.000	0.1024	0.1181
е	0.870	1.030	0.0343	0.0406
e1	1.820	1.980	0.0717	0.0780
L	0.300	0.600	0.0118	0.0236
θ	0 °	8 °	0 °	8 °
х	1.450 TYP		0.057 TYP	
У	0.800 TYP		0.032 TYP	
Z	0.600) TYP	0.024	I TYP



12.2 Flat TO-92 Package Information

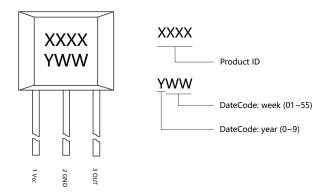


Figure.13 Flat TO-92 Chip Marking Spec

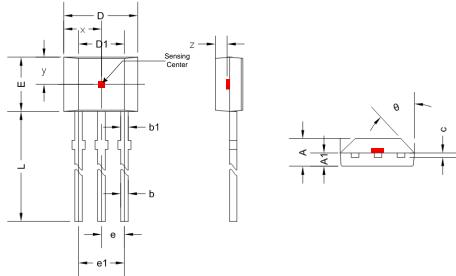


Figure.14 Flat TO-92 Package Drawing

meters	1)imancione in In	
	Dimensions in Inches	
Max	Min	Max
1.620	0.056	0.064
0.860	0.026	0.034
0.480	0.013	0.019
0.510	0.016	0.020
0.510	0.013	0.020
4.100	0.154	0.161
2.680	0.090	0.106
3.250	0.120	0.128
	0.050 TYP	
2.640	0.096	0.104
14.750	0.565	0.581
	45 ° TYP	
	0.080 TYP	
	0.061 TYP	
	1.620 0.860 0.480 0.510 0.510 4.100 2.680 3.250	1.620 0.056 0.860 0.026 0.480 0.013 0.510 0.016 0.510 0.013 4.100 0.154 2.680 0.090 3.250 0.120 0.050 TYP 2.640 0.096 14.750 0.565 45 ° TYP 0.080 TYP



12.3 DFN1608 Package Information

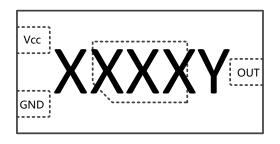
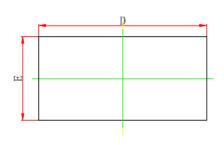
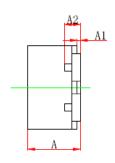




Figure.15 DFN1608 Chip Marking Spec





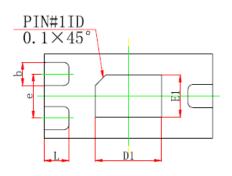


Figure.16 DFN1608 Package Drawing

Symbol	Dimensions in Millimeters		Dimension	s in Inches
	Min	Max	Min	Max
А	0.450	0.550	0.018	0.022
A1	0.000	0.050	0.000	0.002
A2	0.150	0.150 TYP 0.006 TYP		TYP
D	1.550	1.650	0.061	0.065
Е	0.750	0.850	0.030	0.033
D1	0.580	0.680	0.023	0.027
E1	0.350	0.450	0.014	0.018
b	0.170	0.270	0.007	0.011
е	0.420) TYP	0.017	TYP
L	0.185	0.285	0.007	0.011



12.4 DFN1616 Package Information

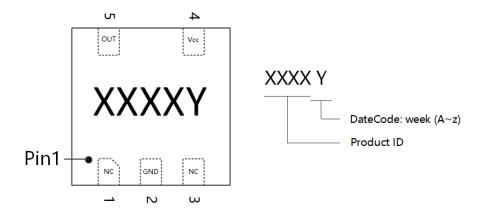


Figure.17 DFN1616 Chip Marking Spec

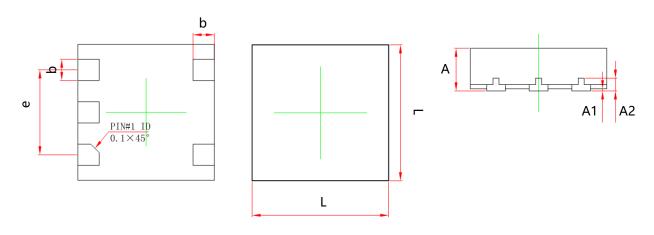


Figure.18 DFN1616 Package Drawing

Symbol	Dimensions in Millimeters		Dimension	s in Inches
	Min	Max	Min	Max
Α	0.450	0.550	0.018	0.022
A1	0.000	0.050	0.000	0.002
A2	0.150	0.150 TYP		TYP
L	1.550	1.650	0.061	0.065
b	0.200	0.300	0.008	0.012
e	1.000 TYP		0.039) TYP



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